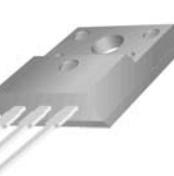
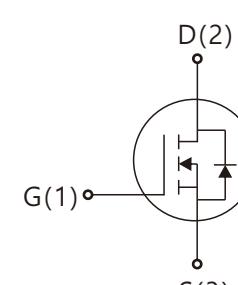


CURRENT 10 Ampere  
VOLTAGE RANG 650 Volts

10N65

<b>10N65</b>  <b>Features:</b> <ul style="list-style-type: none"> <li><input type="checkbox"/> Low Intrinsic Capacitances.</li> <li><input type="checkbox"/> Excellent Switching Characteristics.</li> <li><input type="checkbox"/> Extended Safe Operating Area.</li> <li><input type="checkbox"/> Unrivalled Gate Charge :<math>Q_g = 35\text{nC}</math> (Typ.).</li> <li><input type="checkbox"/> <math>BVDSS = 650\text{ V}</math>, <math>I_D = 10\text{A}</math></li> <li><input type="checkbox"/> <math>R_{DS(on)} : 0.9\ \Omega</math> (Max) @ <math>V_G = 10\text{V}</math></li> <li><input type="checkbox"/> 100% Avalanche Tested</li> </ul>	 <b>TO -220F</b>   <p>1. Gate (G) 2. Drain (D) 3. Source (S)</p>
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### Absolute Maximum Ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain-Source Voltage	650	V
$I_D$	Drain Current	$T_j = 25^\circ\text{C}$	10
		$T_j = 100^\circ\text{C}$	6.7
$V_{GS(TH)}$	Gate Threshold Voltage	30	V
$E_{AS}$	Single Pulse Avalanche Energy (note1)	380	mJ
$I_{AR}$	Avalanche Current (note2)	10	A
$P_D$	Power Dissipation ( $T_j = 25^\circ\text{C}$ )	65	W
$T_j$	Junction Temperature(Max)	150	°C
$T_{stg}$	Storage Temperature	-55~+150	°C
$T_L$	Maximum lead temperature for soldering purpose, 1/8' from case for 5 seconds	300	°C

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance,Junction to Case	-	2.4	°C/W
$R_{\theta JA}$	Thermal Resistance,Junction to Ambient	-	62.5	°C/W

CURRENT 10 Ampere  
VOLTAGE RANG 650 Volts

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## Electrical Characteristics (Ta=25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> =250μA , V <sub>GS</sub> =0	650	-	-	V
△BV <sub>DSS</sub> / △T <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> =250μA , Reference to 25°C	-	0.67	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V	-	-	10	μA
		V <sub>DS</sub> =520V, T <sub>J</sub> =125°C			100	
I <sub>GSSF</sub>	Gate-body leakage Current, Forward	V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V	-	-	100	nA
I <sub>GSSR</sub>	Gate-body leakage Current, Reverse	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V	-	-	-100	
On Characteristics						
V <sub>GS(TH)</sub>	Date Threshold Voltage	I <sub>D</sub> =250μA, V <sub>DS</sub> =V <sub>GS</sub>	2	-	4	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	I <sub>D</sub> =5.0A, V <sub>GS</sub> =10V	-	0.8	0.9	Ω
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V , V <sub>GS</sub> =0 , f=1.0MHz	-	1500	-	pF
C <sub>oss</sub>	Output Capacitance		-	194	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	18	-	
Switching Characteristics						
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =325V , I <sub>D</sub> =10A R <sub>G</sub> =25Ω (Note 3,4)	-	23	-	nS
T <sub>r</sub>	Turn-On Rise Time			15	-	
T <sub>d(off)</sub>	Turn-Off Delay Time		-	90	-	
T <sub>f</sub>	Turn-Off Rise Time		-	30	-	
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =520V, V <sub>GS</sub> =10V , I <sub>D</sub> =10A (Note 3,4)	-	35	-	nC
Q <sub>gs</sub>	Gate-Source Charge			7	-	
Q <sub>gd</sub>	Gate-Drain Charge			18	-	
Drain-Source Diode Characteristics and Maximum Ratings						
I <sub>s</sub>	Max. Diode Forward Current	-		--	10	A
I <sub>SM</sub>	Max. Pulsed Forward Current	-		--	40	
V <sub>SD</sub>	Diode Forward Voltage	I <sub>D</sub> =10A	-	-	1.4	V
T <sub>rr</sub>	Reverse Recovery Time	I <sub>S</sub> =10A, V <sub>GS</sub> =0V diF/dt=100A/μs (Note 3)	-	320	-	nS
Q <sub>rr</sub>	Reverse Recovery Charge		-	4.2	-	μC

Notes : 1, L=0.5mH, IAS= 10A, VDD=50V, RG=25Ω , Starting TJ =25°C

2, Repetitive Rating : Pulse width limited by maximum junction temperature

3, Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

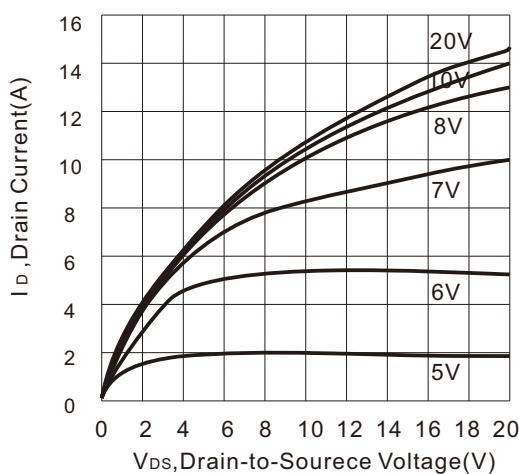
4, Essentially Independent of Operating Temperature

CURRENT 10 Ampere  
VOLTAGE RANG 650 Volts

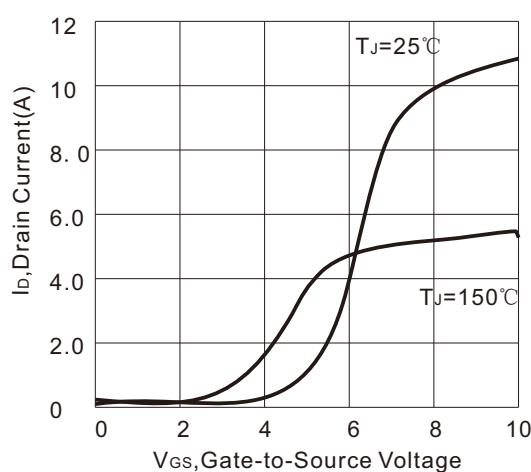
10N65

## Typical Characteristics

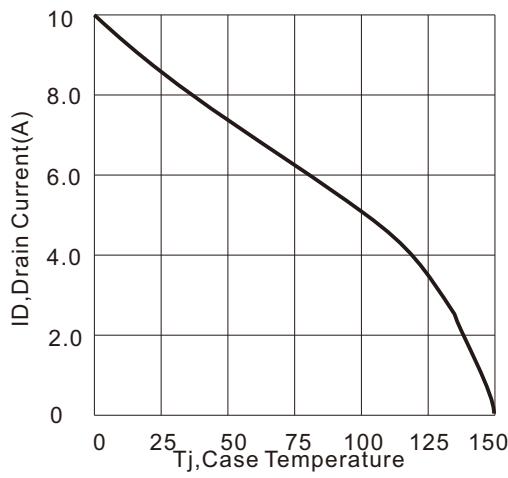
Output Characteristics



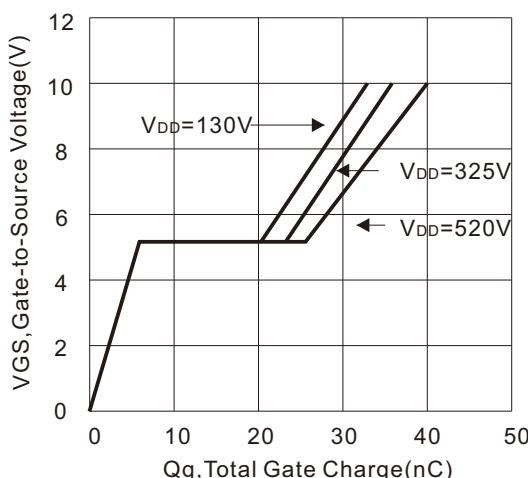
Transfer Characteristics



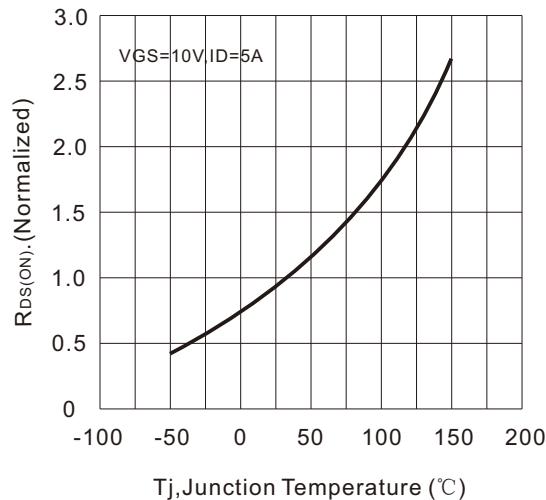
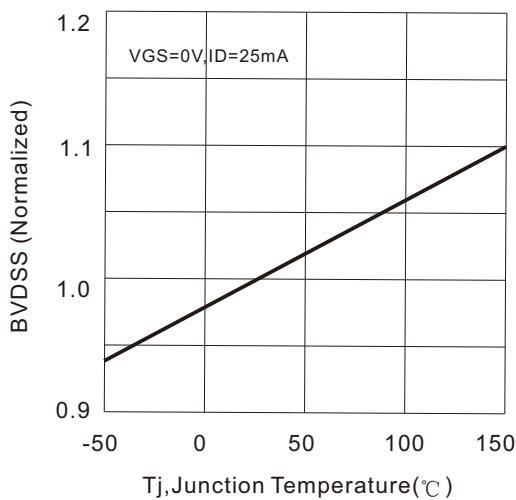
Drain Current VS. Temperature



Gate Charge



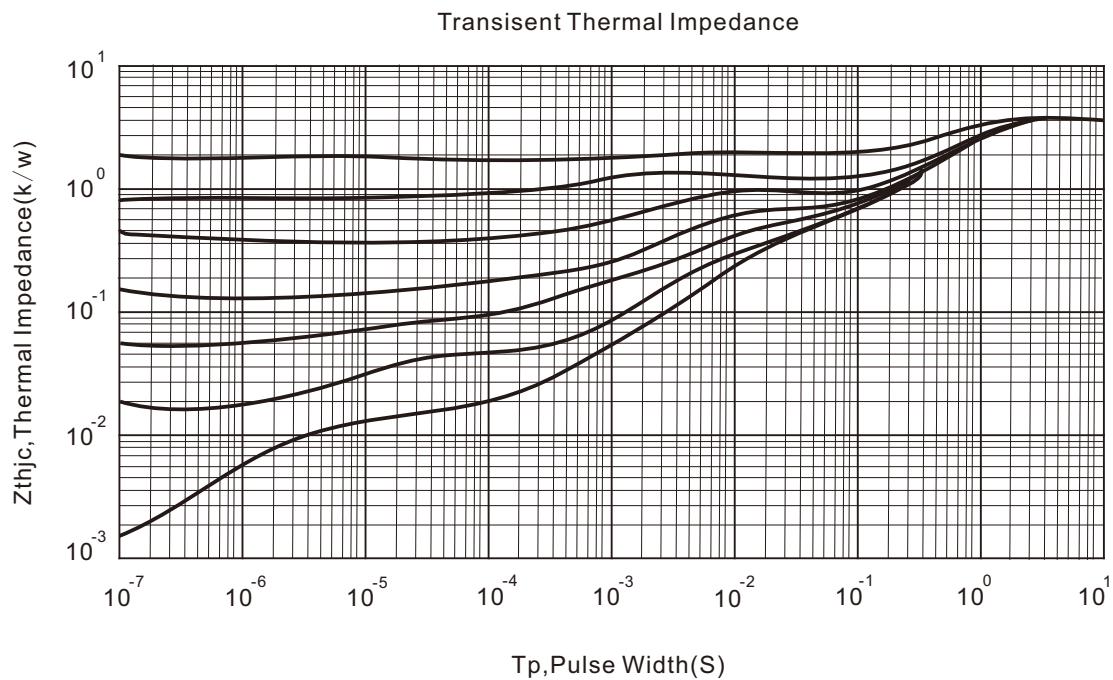
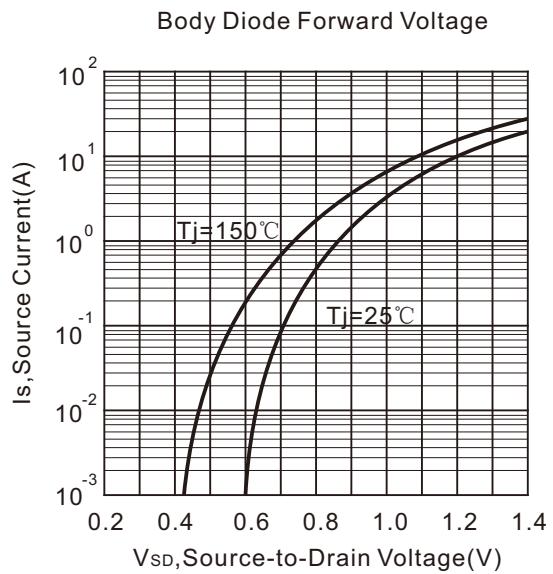
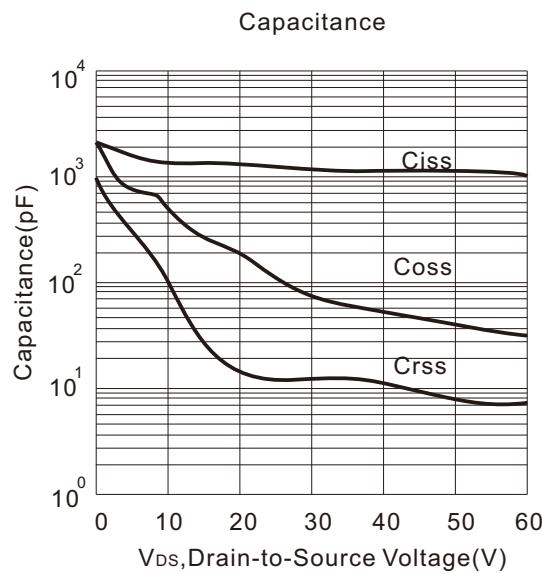
On-Resistance vs. Junction Temperature


 BV<sub>DSS</sub> Variation VS. Temperature


CURRENT 10 Ampere  
VOLTAGE RANG 650 Volts

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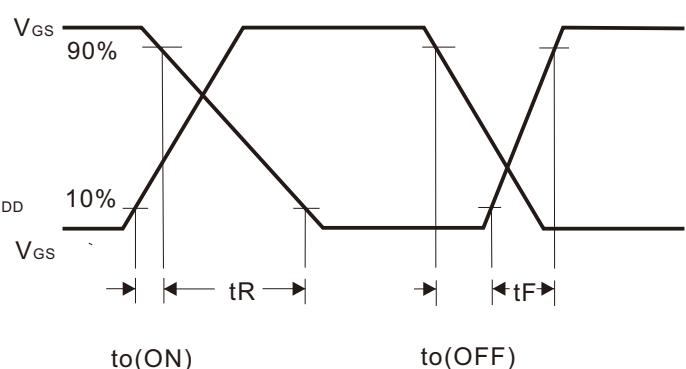
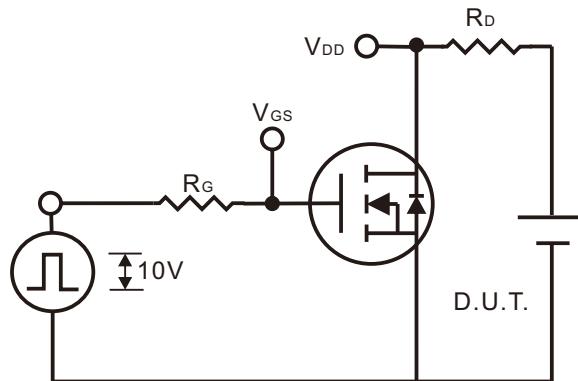
Typical Characteristics (Continued)



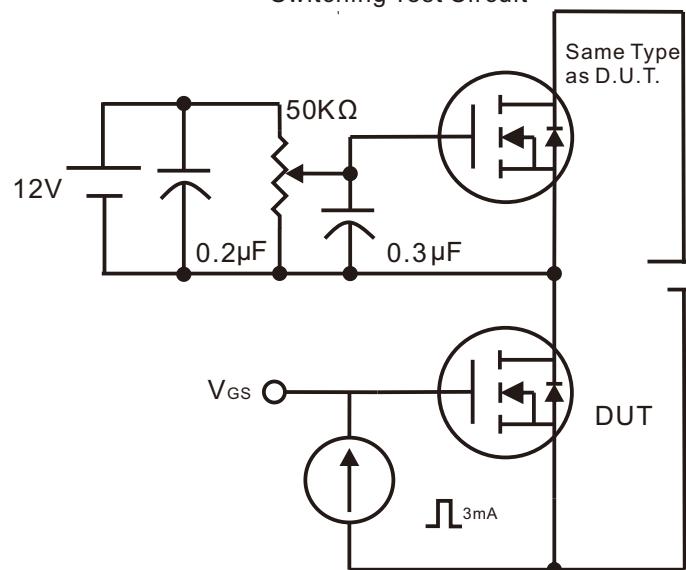
CURRENT 10 Ampere  
VOLTAGE RANG 650 Volts

10N65

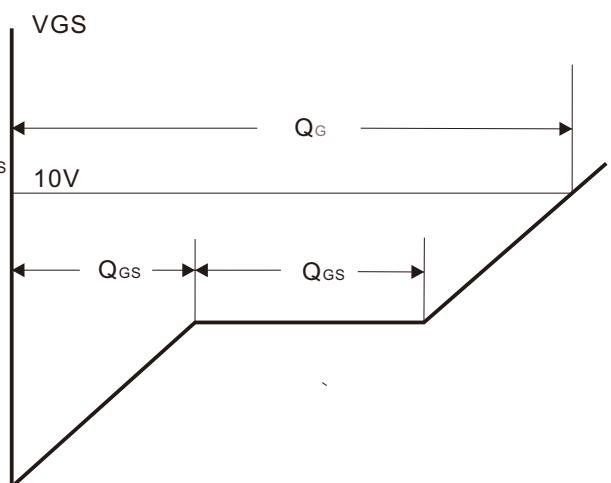
### Gate Charge Test Circuit & Waveform



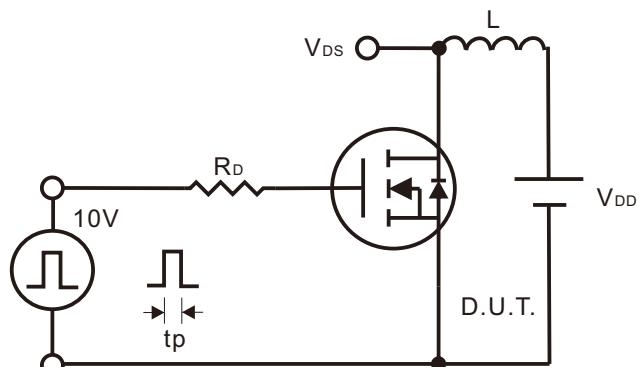
### Switching Test Circuit



### Switching Waveforms

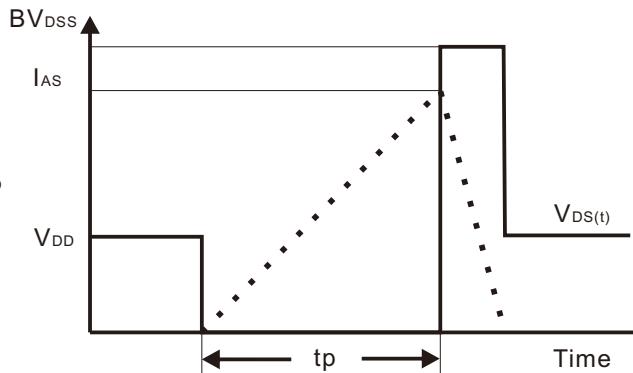


### Gate Charge Test Circuit



Unclamped Inductive Switching Test Circuit

### Gate Charge Waveform

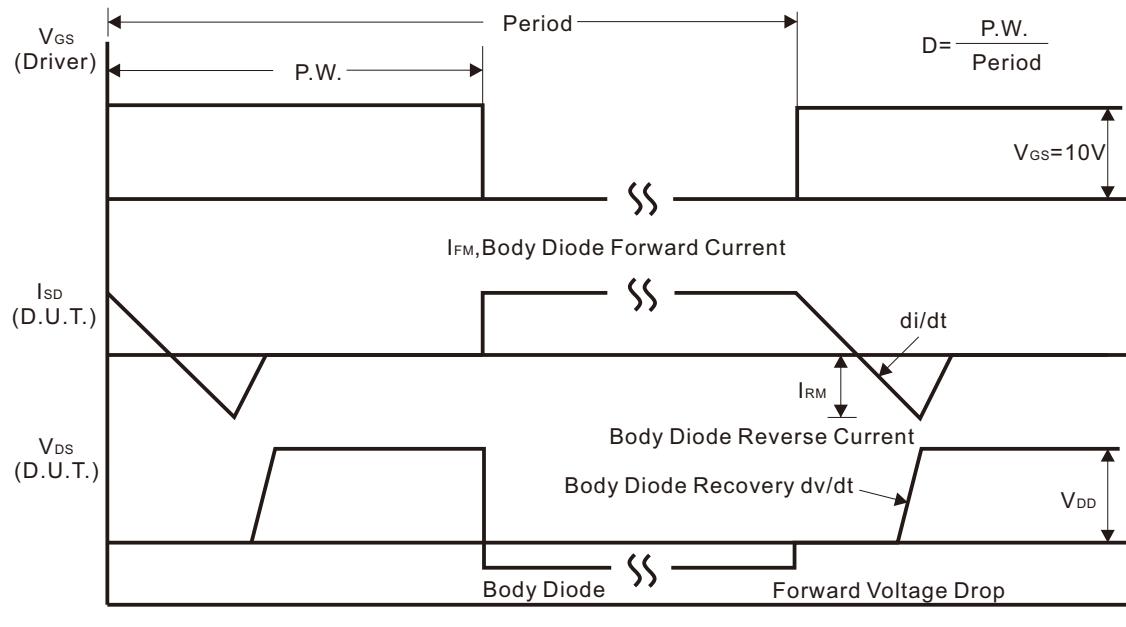
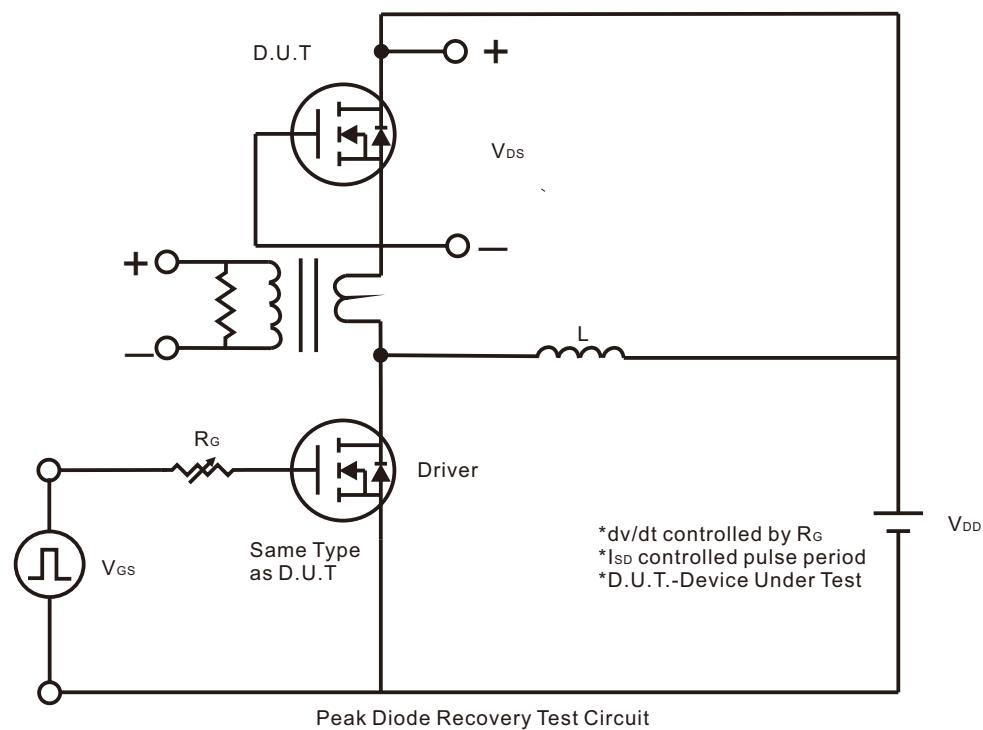


Unclamped Inductive Switching Waveforms

CURRENT 10 Ampere  
VOLTAGE RANG 650 Volts

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### Peak Diode Recovery dv/dt Test Circuit & Waveform



CURRENT 10 Ampere  
VOLTAGE RANG 650 Volts

**10N65**Package Dimension

TO-220F

Unit: mm

